

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMS/19/11862	
1.3 Title of PCN	Transfer of the Assembly and Test & Finishing of some selected SO16 package products	
1.4 Product Category	See product list	
1.5 Issue date	2019-11-26	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Marcello SAN BIAGIO
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	Assembly = ST Shenzhen Test & Finishing = ST Muar

4. Description of change

	Old	New
4.1 Description	Assembly = ST Bouskoura (Morocco) Test & Finishing = ST Bouskoura (Morocco)	Assembly = ST Shenzhen (China) Test & Finishing = ST Muar (Malaysia)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The purpose of this change is to rationalize our production tool and provide a better delivery service. The assembly will be moved to Shenzhen in order to group all the SO16 devices on an optimized process. The Test & Finishing will be moved from Bouskoura to Muar and all the equipment will be transferred to this new plant.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	New finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2019-11-18
7.2 Intended start of delivery	2020-03-02
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	11862 REL.6088-869-2019_New assembly plant ST SHENZHEN-China for SO16_B6AA61.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-11-26

9. Attachments (additional documentations)
11862 Public product.pdf 11862 REL.6088-869-2019_ New assembly plant ST SHENZHEN-China for SO16_B6AA61.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
M40SZ100WMQ6F	M40SZ100WMQ6F	
M41T94MQ6F	M41T94MQ6F	



Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : Transfer of the Assembly and Test & Finishing of some selected SO16 package products

PCN Reference : AMS/19/11862

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

M40SZ100WMQ6F	M41T94MQ6F	
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